

### Global Semiconductor Packaging and Assembly Equipment Market Professional Survey Report 2016

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### **Abstracts**

#### Notes:

Production, means the output of Semiconductor Packaging and Assembly Equipment

Revenue, means the sales value of Semiconductor Packaging and Assembly Equipment

This report studies Semiconductor Packaging and Assembly Equipment in Global market, especially in North America, Europe, China, Japan, Southeast Asia and India, with production, revenue, consumption, import and export in these regions, from 2011 to 2015, and forecast to 2021.

This report focuses on top manufacturers in global market, with production, price, revenue and market share for each manufacturer, covering

**Applied Materials** 

ASM Pacific Technology (ASMPT)

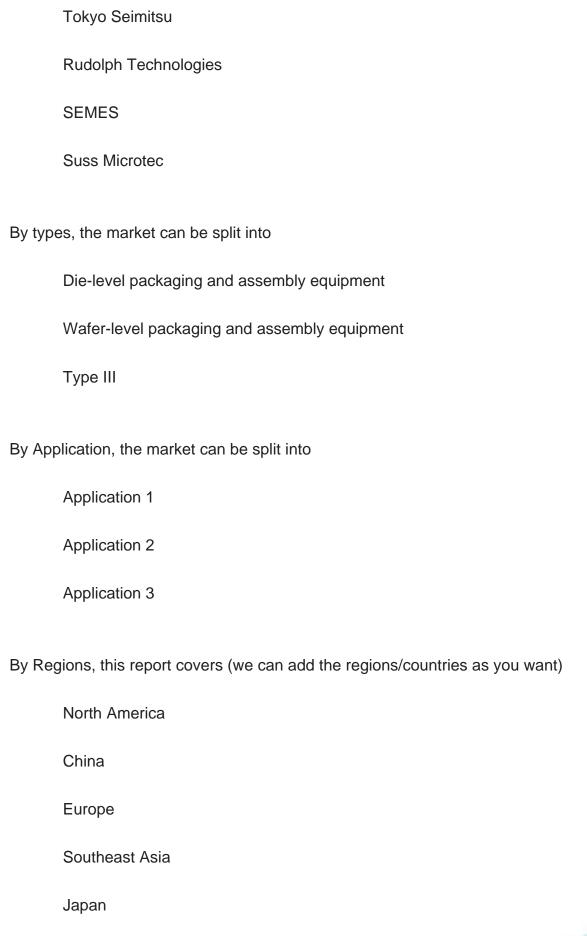
Disco

EV Group (EVG)

Kulicke and Soffa Industries

Tokyo Electron Ltd. (TEL)







India



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